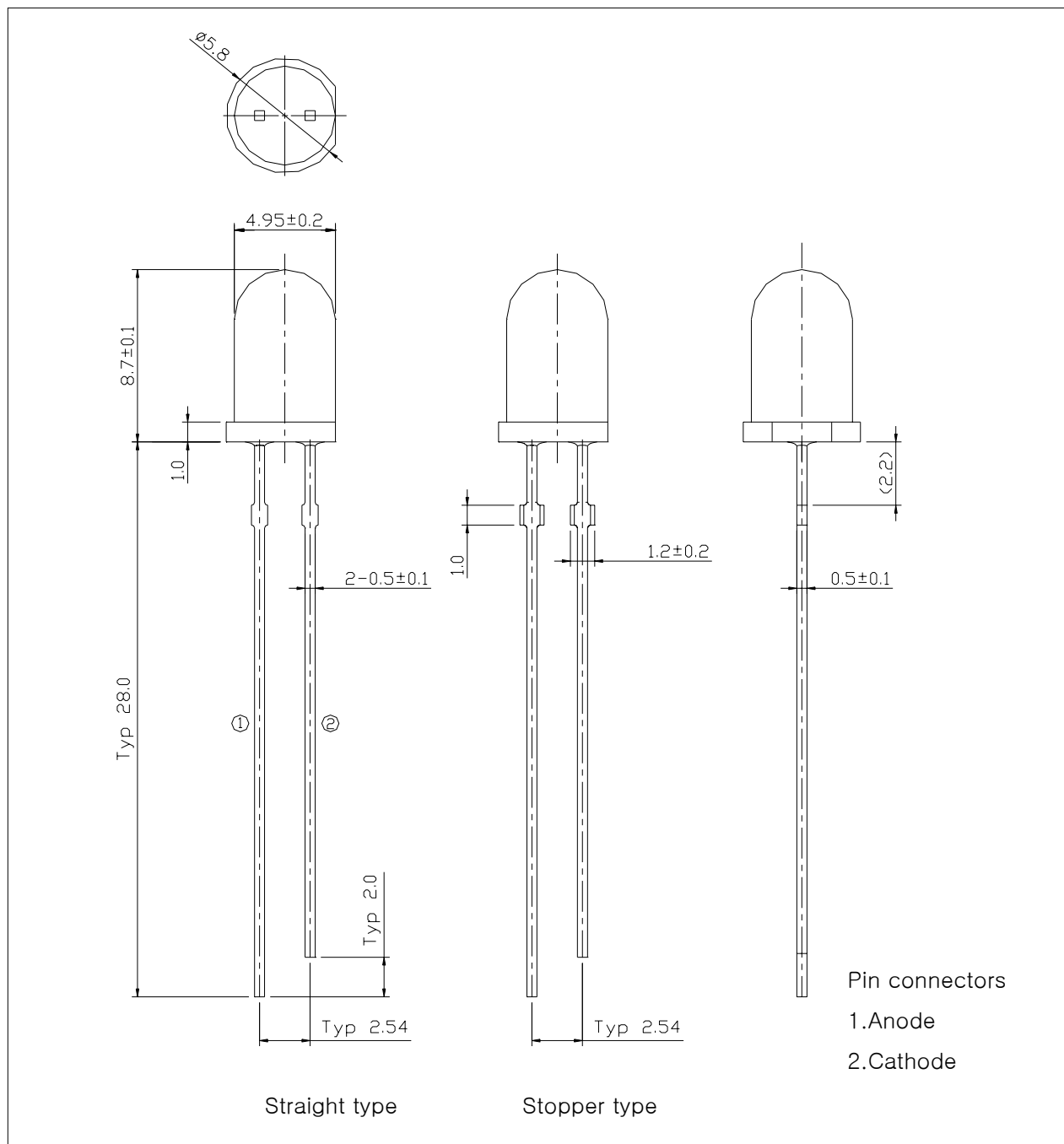


■ Features

- Colorless transparency lens type
- $\phi 5\text{mm}$ (T-1 $\frac{3}{4}$) all plastic mold type
- High Luminosity

■ Outline dimensions

(unit : mm)



■ Absolute Maximum Ratings

Characteristic	Symbol	Ratings	Unit
Power Dissipation	P_D	75	mW
Forward Current	I_F	30	mA
* ¹ Peak Forward Current	I_{FP}	100	mA
Reverse Voltage	V_R	5	V
Operating Temperature	T_{opr}	-30 ~ +85	°C
Storage Temperature	T_{stg}	-40 ~ +100	°C
* ² Soldering Temperature	T_{sol}	260°C for 3 seconds	

*1.Duty ratio = 1/10, Pulse width = 0.1ms

*2.Keep the distance more than 2.0mm from PCB to the bottom of LED package

■ Electrical – Optical Characteristics

($T_a=25^{\circ}\text{C}$)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Forward Voltage	V_F	$I_F=20\text{mA}$	–	2.0	2.7	V
Dominant Wavelength	λ_D	$I_F=20\text{mA}$	–	624	–	nm
Spectrum Bandwidth	$\Delta\lambda$	$I_F=20\text{mA}$	–	15	–	nm
Reverse Current	I_R	$V_R=5\text{V}$	–	–	10	uA
* ³ Half Angle	$\theta_{1/2}$	$I_F=20\text{mA}$	–	± 15	–	deg

*3. $\theta_{1/2}$ is the off-axis angle where the luminous intensity is 1/2 the peak intensity

■ Luminous intensity ranks

(Ta=25℃)

Iv RANK	Test Condition	Min.	Typ.	Max.	Unit
Q	I _F = 20mA	1700	—	2400	mcd
R		2400	—	3400	
S		3400	—	4800	
T		4800	—	6700	

* Luminous intensity is tested at a current pulse duration of 25 ms and an accuracy of ±11%.

* Intensity Measured : 0.01sr(CIE. LED_B)

■ Precautions On LED using

* To avoid optical difference, Please do not mix differently-ranked product.

■ Characteristic Diagrams

Fig. 1 I_F - V_F

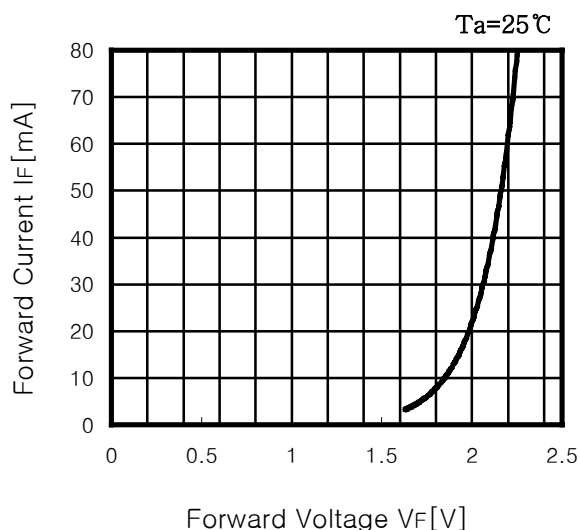


Fig. 2 I_v - I_F

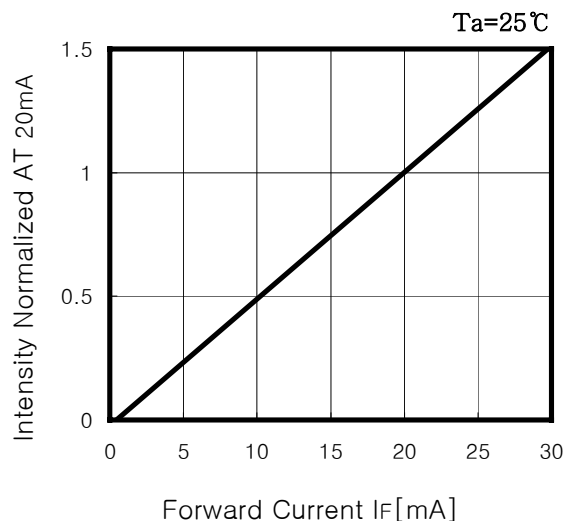


Fig. 3 Spectrum Distribution

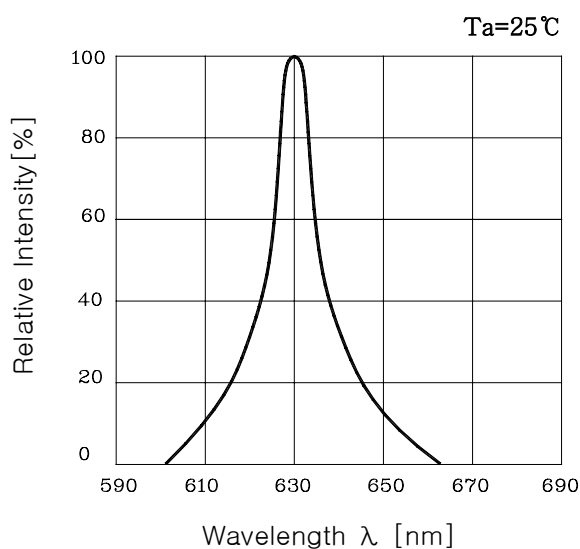


Fig. 4 Relative Intensity- T_a

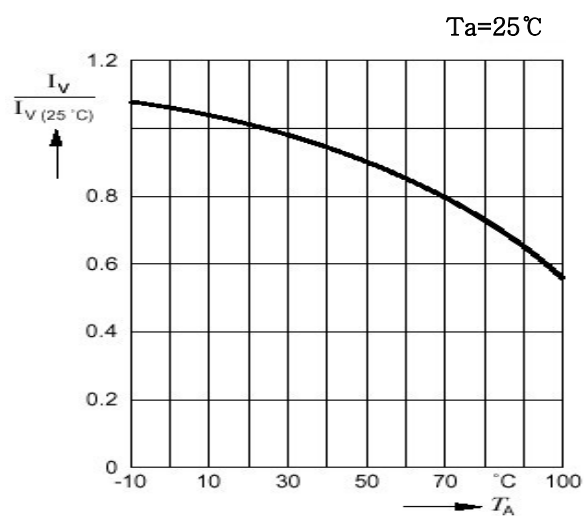
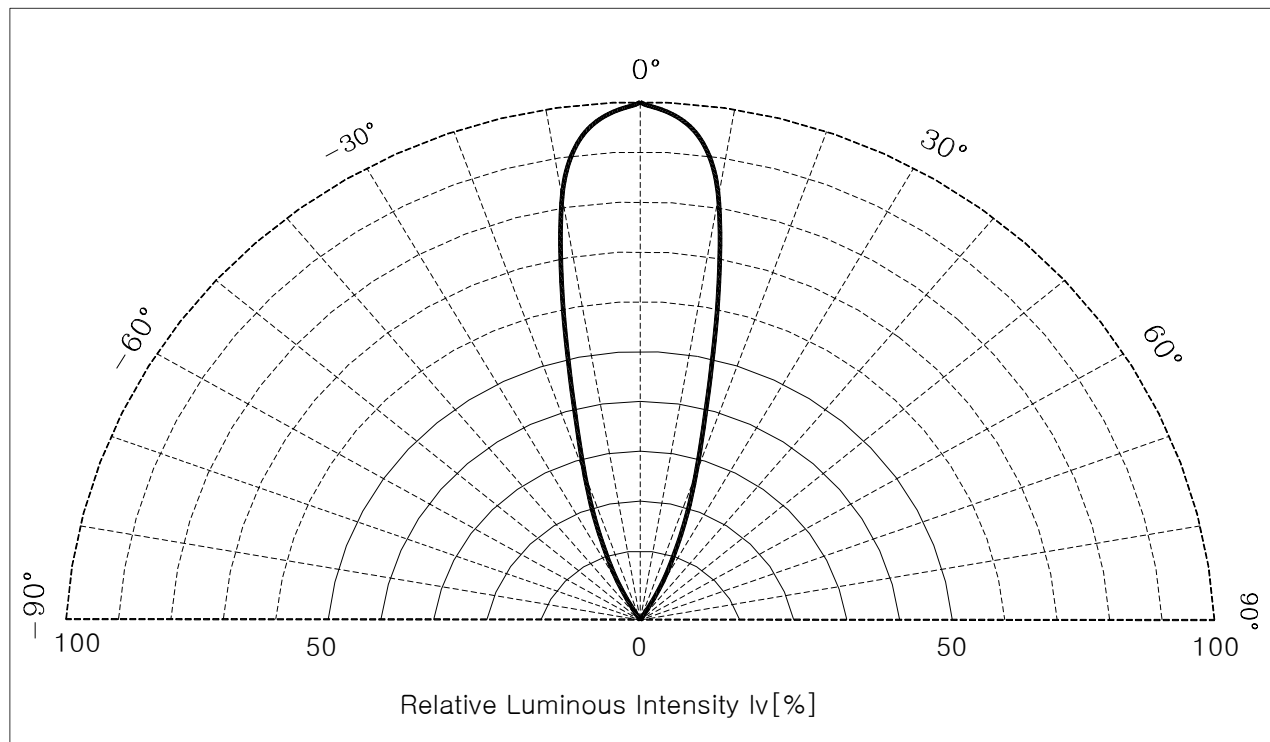


Fig. 5 Radiation Diagram



[illegible]